Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	57	((interlevel) near2 (dielectric)) and (polymer) and (sacrificial) and ((low-k) or (" low k") or (k-dielectric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/09 09:54
52	9	((interlevel) near2 (dielectric)) and ((polymer) near3 (sacrificial)) and ((low-k) or (" low k") or (k-dielectric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/09 09:56
S3	173	(interlevel) and (polymer) and (sacrificial) and (@ad<="20031208")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/09 11:13
S4	60	(interlevel) and (polymer) and (sacrificial) and ((etch\$3) adj2 (back)) and (@ad<="20031208")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/09 12:07
S8	1203	((air) adj\$2 (gap)) and (dielectric) and (polymer) and ((interlevel) or (ILD)) and (@ad<="20031208")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/09 12:11
S9	234	((air) adj\$2 (gap)) and (dielectric) and (polymer) and (sacrificial) and ((interlevel) or (ILD)) and (@ad<="20031208")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 08:56
S10	555	(@ad<="20031208") and ((sacrificial) same (metal\$4) same (deposit\$4) same (photoresist))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 09:40
S11	106	(@ad<="20031208") and ((sacrificial) same ((metal\$4) near (deposit\$4)) same (photoresist))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 09:46
S12	3	·(@ad<="20031208") and ((sacrificial) same ((metal\$4) near (deposit\$4)) same (photoresist)) same (cap\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/30 09:52
S13	51	(@ad<="20031208") and ((sacrificial) same ((metal\$4) near (deposit\$4)) same (photoresist)) and (cap\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 13:50

514	137	(@ad<="20031208") and (((metal) or (copper)) adj3 (top) adj3 (photoresist))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 14:15
S15	. 46	(@ad<="20031208") and (((metal) or (copper)) adj3 (top) adj3 (photoresist)) and (copper)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 07:14
S16	2	(@ad<="20031208") and (((metal) or (copper)) adj3 (top) adj3 (photoresist)) and (copper) and ((cap) adj (layer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 07:15
S17	3	("6303464").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/28 18:38
S18	2	("6146986").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/28 18:38
519	2	("6416986").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/29 18:46
S20	2	("6146986").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/29 18:46
521	144	(@ad<="20031208") and (438/42.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 09:16
S22	151	(438/42.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:09
S23	0	("interlevel dielectric").ti. and "mask.ti"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 09:19

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S24	7	("interlevel dielectric").ti. and mask.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 09:45
S25	0	("interlevel dielectric").ti. and sacrificial.ab. and metal.ab. and cap.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 09:46
S26	0	("interlevel dielectric").ti. and sacrificial.ab. and metal.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 09:46
S27	5	("interlevel dielectric").ti. and sacrificial.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:01
S28	6	("interlevel dielectric").ti. and deposition.ab. and etch.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:02
S29	931	(438/702.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:11
S30	1928	(438/706.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:11
S31	1426	(438/710.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:14
S32	1	rhee-Seung-hyun.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:16
S33	20	huang-richard.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:17

534	7	gabriel-calvin.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/04 10:27
S35	2	("6232663").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/04 10:28
S36	2	("6388309").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/04 10:28

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